AN3310K, AN3310S

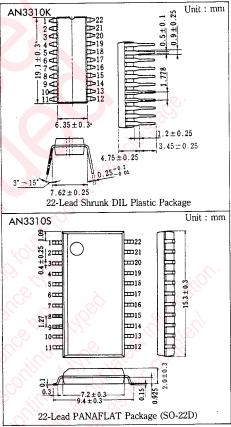
Head Amplifier Circuits for VTR (4-Head Type)

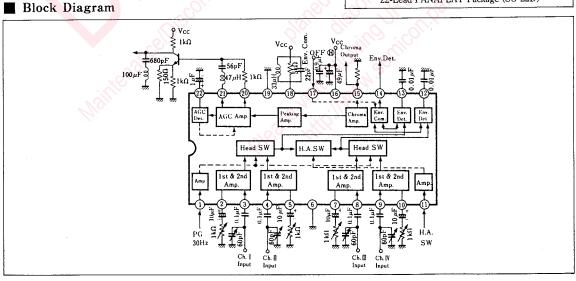
📕 Outline

The AN3310K and the AN3310S are integrated circuits designed for head amplifier circuits for VTR (4-head type).

Features

- · Built-in enveloped comparing circuit
- · Built-in peaking amplifier circuit
- Less noise voltage referred to input : 1μ Vrms)
- Supply voltage : $V_{cc} = 5V_{cc}$





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Pin

Pin No.	Pin Name	Pin No.	Pin Name
1	Head SW Changeover	12	Ch. I, I Side Envelope Detection
2	Initial Stage Bias(Ch. 1)	13	Ch. Ⅲ, Ⅳ Side Envelope Detection
3	Initial Stage Input(Ch. I)	14	Envelope Comparative Output
4	Initial Stage Input(Ch. II)	15	Chroma Output
5	Initial Stage Bias(Ch. II)	16	V _{cc}
6	Input Stage GND	17	Envelope Comparative Circuit Stop SW
7	Initial Stage Bias(Ch. Ⅲ)	18	Peaking Circuit Peak Constant
8	Initial Stage Input(Ch. II)	19	Output Stage GND
9	Initial Stage Input(Ch. N)	20	AGC Output
10	Initial Stage Bias(Ch. N)	21	AGC Reverse Phase Output
11	Head Amp. SW Changeover	22	AGC Control Signal Detection

■ Absolute Maximum Ratings (Ta=25℃)

Item	Symbol	Rating	Unit
Supply Voltage	Vc	6.0	· V
Power Dissipation(Ta=70°C)	PD	250	mW
Operating Ambient Temperature	Topr	-20~+70	°C
Storage Temperature	T _{stg}	-55~+150	°C

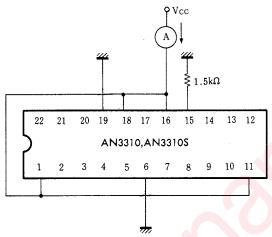
Electrical Characteristics (Ta=25°C)

Item	Symbol	Test Circuit	Condition	min.	typ.	max.	Unit
Circuit Current	I ₁₆	1	V _{cc} =5V	16	5	40	mA
Ch. I Gain	G ₃₋₁₅	2	V _{CC} =5V, f=1MHz	50.5		60.5	dB
Ch. I Gain	G ₄₋₁₅	2	V _{CC} =5V, f=1MHz	50.5		60.5	dB
Ch. III Gain	G ₈₋₁₅	2	V _{CC} =5V, f=1MHz	< 50.5		60.5	dB
Ch. N Gain	G ₉₋₁₅	2	V _{CC} =5V, f=1MHz	50.5		60.5	dB
AGC Output Amplitude	v_{20}	3	V _{CC} =5V, f=4MHz	100		190	mv _{P-P}
AGC Control Sensitivity	v_{20}	3	V _{cc} =5V, f=4MHz			3	dB
H.SW Changeover Sensitivity	S1	2	V _{CC} =5V			1	v
H.A.SW Changeover Sensitivity	S ₁₁	2	V _{CC} =5V			1	v
Noise voltage Referred to Input(1)	V _{ni3-15}	4	V _{CC} =5V, 1MHz BPF			1	μV_{rms}
Noise voltage Referred to Input(1)	V _{ni4-15}	4	V _{CC} =5V, 1MHz BPF			1	μV_{rms}
Noise voltage Referred to Input(II)	V _{ni8-15}	4	V _{CC} =5V, 1MHz BPF			1	μV_{rms}
Noise voltage Referred to Input(N)	V _{ni9-15}	4	V _{CC} =5V, 1MHz BPF			1	μV_{rms}
Envelope Comparative Output Amplitude	v_{14}	5	V _{CC} =5V	4.3			V _{P-P}
Envelope Comparative Output Stop Sensitivity	S ₁₇	5	V _{cc} =5V			1.2	V

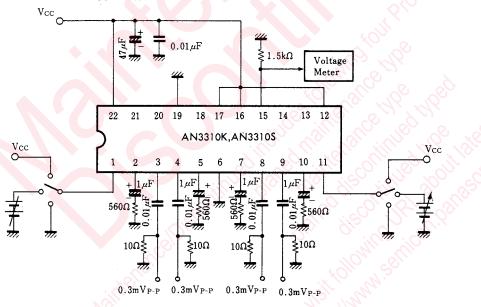
Note : Operating Supply Voltage Range : V_{CC(opr)})=4.5~5.5V

IC's FOR VTR

Test Circuit 1 (I₁₆)



Test Circuit 2 (G₃₋₁₅, G₄₋₁₅, G₈₋₁₅, G₉₋₁₅, S₁, S₁₁)



Item	1)Pin	1)Pin	Input Pin <
G _{3 15}	V _{CC}	GND	3
G ₄₋₁₅	GND	GND	4
G _{8 15}	V _{CC}	V _{cc}	8
G9 15	GND	V _{CC}	9

• S_1 , S_{11} : Pin ④ 0.3m V_{P-P} input (fin=1MHz)

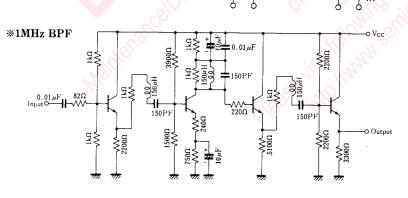
- S1: Decreasing the electric potential of Pin ① from Vcc, measure the electric potential of Pin ① when Pin ⑤ output appears.
- Su: Decreasing the electric potential of Pin (1) from Vcc, measure the electric potential of Pin (1) when Pin (1) output appears.

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AN3310K, AN3310S

Test Circuit 3 (v_{20} , Δv_{20}) 51kΩ Vcc o 0.01 µF $47 \mu F$ • v₂₀: Pin ③ input 0.3mV_{P-P} 22PF 33 aH Voltage Meter ● △ v20: Pin ③ input 0.15~0.6mV_{P-P} $1\mu F$ 22 20 19 16 15 13 12 21 18 17 14 AN3310, AN33105 1 2 3 ٨ 5 6 7 8 9 10 11 1μ + 1 µF 560Ω≷ 61 560Ω 10Ω≹ Test Circuit 4 (V_{ni3-15}, V_{ni4-15}, V_{ni8-15}, V_{ni9-15}) Vcc o 1.5kΩ * 0.01µF 1MHz Voltage BPF Meter 22 21 20 19 18 17 16 15 14 13 12 AN3310K, AN3310S Vcc 3 0 1 2 4 5 6 7 8 9 10 11 --0 Vcc $\pm 11 \mu$ 1µF + lμF 01 [77] J-≷ 560Ω 560Ω ≹ 0.01 01 JuF 01/4] 0



10Ω

≷10Ω

100

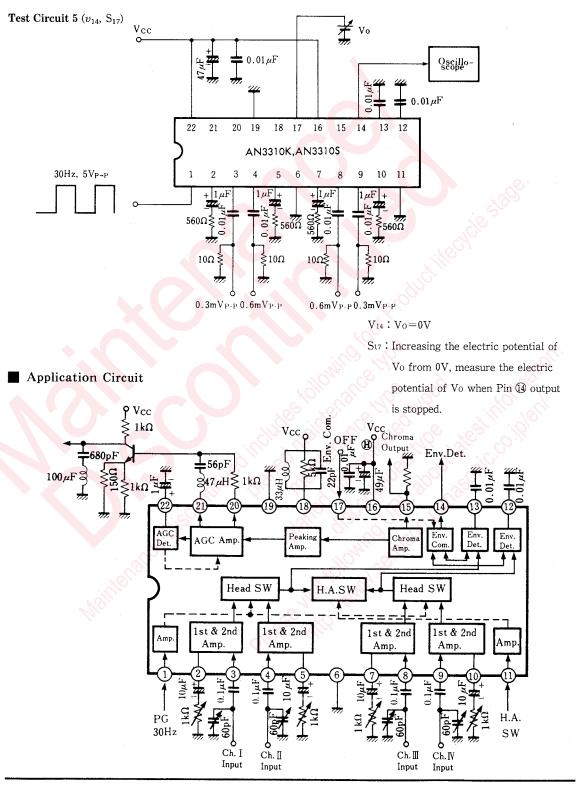
0Ω

Item	Pin(1)	Pin(1)
V _{ni3-15}	v_{cc}	GND
V _{ni4-15}	GND	GND
V _{ni8-15}	V _{CC}	V _{CC}
V _{ni9-15}	GND	V _{CC}

◎ Notes for Handling

Since deterioration or destroy of characteristics may occur due to flow of overcurrent caused by the wrong insertion careful ¹attention should be taken to handling.

IC's FOR VTR



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